PNP -3.0A -50V Power Transistor

Datasheet

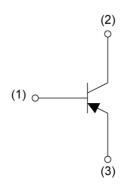
## **AEC-Q101 Qualified**

Parameter	Value
V <sub>CEO</sub>	-50V
I <sub>C</sub>	-3A

# DPAK TO-252

#### Features

- 1) Suitable for Power Driver.
- 2) Complementary NPN Types: 2SCR573D3 FRA.
- 3) Low  $V_{CE(sat)}$   $V_{CE(sat)}$ =-400mV(Max.). ( $I_C/I_B$ =-1A/-50mA)



## ●Inner circuit

Outline

- (1) Base
- (2) Collector(3) Emitter

Application

LOW FREQUENCY AMPLIFIER

## Packaging specifications

Part No.	Package	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SAR573D3 FRA	TO-252 (DPAK)	TL	330	16	2500	2SAR573D3

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	$V_{CBO}$	-50	V
Collector-emitter voltage	V <sub>CEO</sub>	-50	V
Emitter-base voltage	V <sub>EBO</sub>	-6	V
Collector ourse of	I <sub>C</sub>	-3	Α
Collector current	I <sub>CP</sub> *1	-6	Α
Power dissipation	P <sub>D</sub> *2	10	W
Junction temperature	T <sub>j</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

## ● Electrical characteristics (T<sub>a</sub> = 25°C)

Darameter	Cymbol	Conditions	Values			l loit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = -100μA	-50	ı	1	V	
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = -1mA	-50	1	1	V	
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = -100μA	-6	-	-	V	
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -50V	-	-	-1	μA	
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -4V	-	-	-1	μA	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -1A$ , $I_B = -50mA$	-	-200	-400	mV	
DC current gain	h <sub>FE</sub>	$V_{CE} = -3V, I_{C} = -100 \text{mA}$	180	ı	450	-	
Transition frequency	f <sub>T</sub> *3	V <sub>CE</sub> = -10V, I <sub>E</sub> = 200mA, f = 100MHz	-	300	-	MHz	
Output capacitance	C <sub>ob</sub>	$V_{CB} = -10V$ , $I_E = 0A$ , $f = 1MHz$	ı	35	1	pF	
Turn-On time	t <sub>on</sub>	I <sub>C</sub> = -1.5A, I <sub>B1</sub> = -150mA,	ı	50	ı	ns	
Storage time	$t_{stg}$	$I_{B2} = 150 \text{mA},$ $V_{CC} \approx -10 \text{V},$	ı	450	ı	ns	
Fall time	t <sub>f</sub>	$R_L = 6.8\Omega$ See test circuit	-	100	-	ns	

<sup>\*1</sup> Pw=10ms Single Pulse

<sup>\*2</sup> Tc=25℃

<sup>\*3</sup> Pulsed

## ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.1 Grounded Emitter Propagation Characteristics

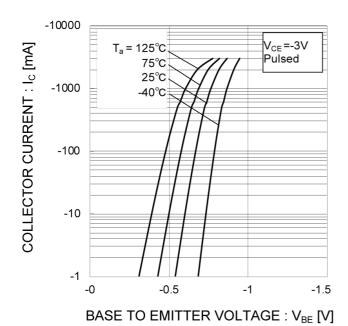
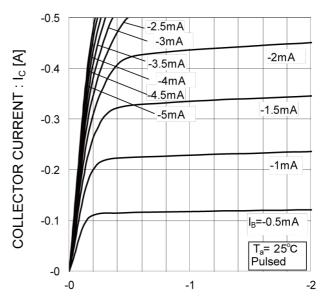


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.3 DC Current Gain vs. Collector Current(I)

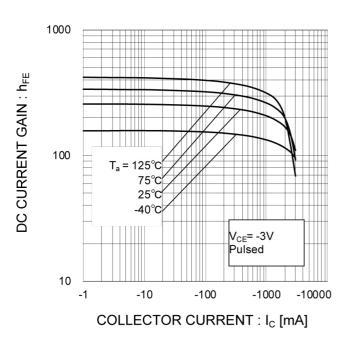
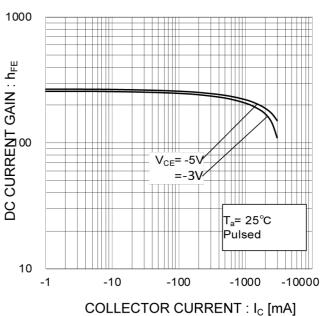
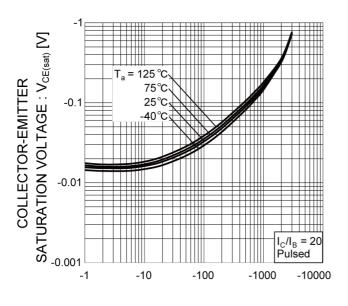


Fig.4 DC Current Gain vs. Collector Current(II)



## ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current(I)



COLLECTOR CURRENT: Ic [mA]

Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current(II)

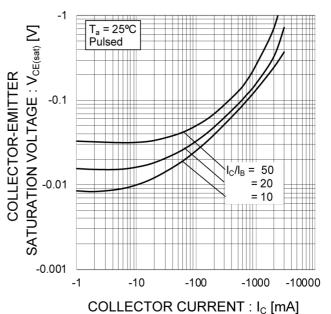


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

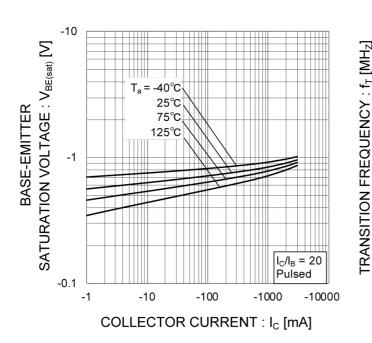
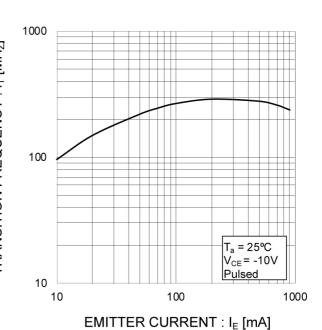


Fig.8 Gain Bandwidth Product vs. Emitter Current



ROHM

## ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.9 Emitter input capacitance vs.

**Emitter-Base Voltage** 

Collector output capacitance vs.

Collector-Base Voltage

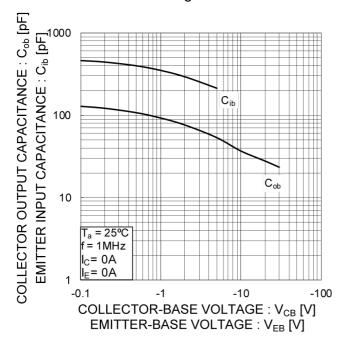
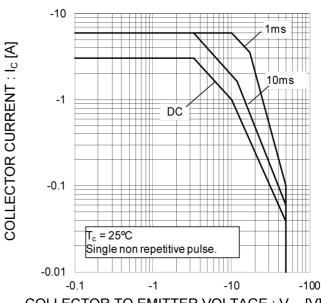
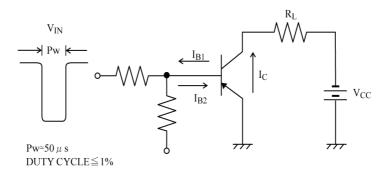


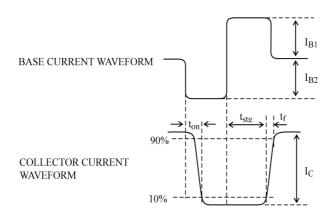
Fig.10 Safe Operating Area



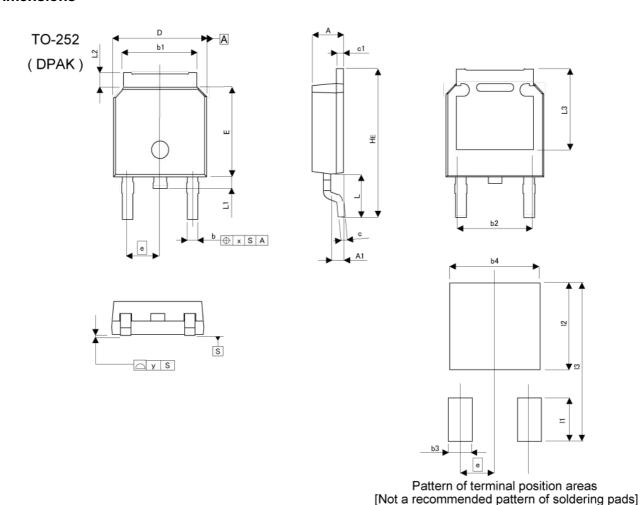
## COLLECTOR TO EMITTER VOLTAGE : $V_{\text{CE}}\left[V\right]$

#### SWITCHING TIME TEST CIRCUIT





## Dimensions



**INCHES** MILIMETERS DIM MIN MAX MIN MAX 2.10 0.083 0.091 Α 2.30 A1 0.70 1.10 0.028 0.043 b 0.65 0.85 0.026 0.033 0.213 5.10 5.40 b1 0.201 b2 5.10 0.201 0.40 0.60 0.016 0.024 C 0.40 0.60 0.016 0.024 c1 D 6.40 6.80 0.252 0.268 е 0.236 6.00 6.40 0.252 E HE 9.50 10.50 0.374 0.413 0.114 0.70 0.028 0.035 L1 0.90 0.70 0.028 L2 1.30 0.051 L3 0.209 0.10 0.004 Х у 0.10 0.004

MILIMETERS INCHES DIM MIN MAX MIN MAX b3 1.10 0.043 5.40 0.213 b4 11 2.90 0.114 12 5.50 0.217 10.50 13 0.413

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	OL ACOM	CLASS II b	ОГУООШ
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - If Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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